L Number	Hits	Search Text	DB	Time stamp
-	9	"6208025"	USPAT;	2003/06/10 10:13
			US-PGPUB;	
			EPO; JPO;	
		W 400 400 4W	DERWENT	2003/06/06 12:41
-	22	"6086386"	USPAT;	2003/06/06 12:41
			US-PGPUB;	
			EPO; JPO; DERWENT	
	1.0	HE 0710E2H	USPAT;	2003/06/06 12:42
-	19	"5971253"	US-PGPUB;	2003/00/00 12:42
			EPO; JPO;	
			DERWENT	
_	7	"5956235"	USPAT;	2003/06/06 12:43
	,	3330233	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
_	16	"5953623"	USPAT;	2003/06/06 12:43
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
-	22	"5885849"	USPAT;	2003/06/06 12:44
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	0000/06/06 10 46
-	58	"5861666"	USPAT;	2003/06/06 12:46
			US-PGPUB;	
			EPO; JPO; DERWENT	
	3.5	#5000C00#	USPAT;	2003/06/06 12:46
-	35	"5802699"	US-PGPUB;	2003/00/00 12:40
			EPO; JPO;	
			DERWENT	
_	40	"5801446"	USPAT;	2003/06/10 10:15
	40	3001110	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
_	15	"5708304"	USPAT;	2003/06/10 10:17
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	0000 (05 (10 10 10
-	26	"5705858"	USPAT;	2003/06/10 10:18
			US-PGPUB;	
			EPO; JPO;	
	4.1	HE CCC000H	DERWENT USPAT;	2003/06/10 10:20
_	41	"5666008"	US-PGPUB;	2003/00/10 10:20
			EPO; JPO;	
			DERWENT	
_	50	"5641996"	USPAT;	2003/06/10 10:21
		0011330	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
l -	220	"5518964" not ("5801446" "5708304"	USPAT;	2003/06/10 10:23
		"5705858" "5666008" "5641996")	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
_	14	"5204455"	USPAT;	2003/06/10 10:24
			US-PGPUB;	
			EPO; JPO;	
		#5240500#	DERWENT	2002/06/10 10:05
-	33	"5349500"	USPAT;	2003/06/10 10:25
			US-PGPUB;	
			EPO; JPO; DERWENT	
	11	"5436503"	USPAT;	2003/06/10 10:25
-	41	J430303	US-PGPUB;	2303,00,10 10.23
1			EPO; JPO;	

	224	"5518964"	USPAT;	2003/06/10 10:29
		3010301	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
_	339	"5148265"	USPAT;	2003/06/10 10:29
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
-	316	"5148266"	USPAT;	2003/06/10 10:30
			US-PGPUB;	
1			EPO; JPO;	
			DERWENT	0000/05/10 11 55
-	2822	(conductive near element) and core	USPAT;	2003/06/10 11:56
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	2002/06/10 11:44
-	1411	((conductive near element) and core) and	USPAT;	2003/06/10 11:44
		temperature	US-PGPUB; EPO; JPO;	
			DERWENT	
	389	///conductive mean element) and core) and	USPAT;	2003/06/10 11:44
_	389	(((conductive near element) and core) and temperature) and chip	US-PGPUB;	2003,00,10 11.44
		(cemperature) and chip	EPO; JPO;	
			DERWENT	
_	39	((conductive near element) near (Sn Bi Pb	USPAT;	2003/06/10 11:59
		In Cd tin lead bismuth indium cadium)) and	US-PGPUB;	3, 33,
		core	EPO; JPO;	
		5525	DERWENT	